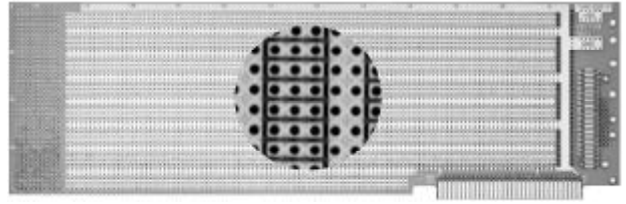


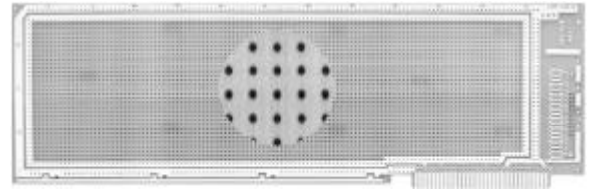
## 4613 IBM PC, XT

<b>Circuit Pattern:</b>	3-Hole Solder Pad	<ul style="list-style-type: none"> <li>• 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads</li> <li>• I/O mounting area for 37-pin D-subminiature and ribbon cable connectors</li> <li>• Mounting bracket and hardware kit included (HD36B)</li> <li>• Layout paper and instructions included</li> </ul>
<b>Contacts:</b>	31/62 @ .01" Ctrs, Ni/Gold	
<b>Width/Thick:</b>	13.25"/0.062"	
<b>Height:</b>	4.2"	
<b>16-Pin DIP Capacity:</b>	44	
<b>Material:</b>	FR4 Epoxy Glass	
<b>V/G Terminals:</b>	T44, T46, T49, T68	
<b>Socket Pins:</b>	R32	
<b>Extender:</b>	3690-22	
<b>Hole Diameter:</b>	.042"	



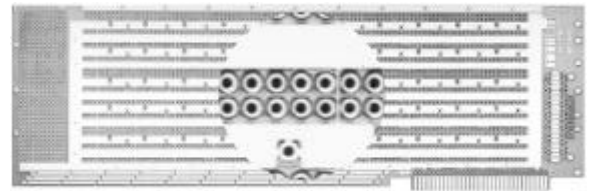
## 4613-1 IBM PC, XT

<b>Circuit Pattern:</b>	Peripheral Buses	<ul style="list-style-type: none"> <li>• Voltage and ground buses around board perimeter, both sides</li> <li>• Auxiliary bus line along lower edge of board, both sides</li> <li>• I/O mounting area for 37-pin D-subminiature and ribbon cable connectors</li> <li>• Mounting bracket and hardware kit included (HD36B)</li> <li>• Layout paper and instructions included</li> </ul>
<b>Contacts:</b>	31/62 @ .01" Ctrs, Ni/Gold	
<b>Width/Thick:</b>	13.25"/.062"	
<b>Height:</b>	4.2"	
<b>16-Pin DIP Capacity:</b>	93	
<b>Material:</b>	FR4 Epoxy Glass	
<b>V/G Terminals:</b>	T44, T46, T49, T68	
<b>Socket Pins:</b>	R32	
<b>Extender:</b>	3690-22	
<b>Hole Diameter:</b>	.042"	



## 4613-2 IBM PC, XT

<b>Circuit Pattern:</b>	Voltage/Ground Planes	<ul style="list-style-type: none"> <li>• Full voltage and ground planes on opposite sides</li> <li>• Three auxiliary bus lines along edge of board</li> <li>• 12 x 39 grid unrestricted component placement area with 0.080" diameter, isolated solder pads around holes</li> <li>• Layout paper and instructions included</li> <li>• Mounting bracket and hardware included (HD36B)</li> </ul>
<b>Contacts:</b>	31/62 @ .01" Ctrs, Ni/Gold	
<b>Width/Thick:</b>	13.25"/.062"	
<b>Height:</b>	4.2"	
<b>16-Pin DIP Capacity:</b>	154	
<b>Material:</b>	FR4 Epoxy Glass	
<b>V/G Terminals:</b>	T44, T46, T49, T68	
<b>Socket Pins:</b>	R32	
<b>Extender:</b>	3690-22	
<b>Hole Diameter:</b>	.042"	



## 4613-3 IBM PC, XT

<b>Circuit Pattern:</b>	Pad-Per-Hole	<ul style="list-style-type: none"> <li>• Plated-thru holes</li> <li>• Voltage and ground buses around board perimeter</li> <li>• I/O mounting area for 37-pin D-subminiature and ribbon cable connectors</li> <li>• Layout paper and instructions included</li> <li>• Mounting bracket and hardware included (HD36B)</li> </ul>
<b>Contacts:</b>	31/62 @ .01" Ctrs, Ni/Gold	
<b>Width/Thick:</b>	13.25"/.062"	
<b>Height:</b>	4.2"	
<b>16-Pin DIP Capacity:</b>	154	
<b>Material:</b>	FR4 Epoxy Glass	
<b>V/G Terminals:</b>	T44, T46, T49, T68	
<b>Socket Pins:</b>	R32	
<b>Extender:</b>	3690-22	
<b>Hole Diameter:</b>	.042"	

